HI-TEMP ADHESIVES

Single Component - Alumina

3000°F - RESBOND 989

Alumina Adhesive

Resbond 989 is a one component high purity, 3000°F Alumina based, general purpose adhesive.

It has a smooth creamy consistency and cures at room temperature to form strong bonds to ceramics, graphite, metals and glass.

Resbond 989 is resistant to oxidation, electricity, molten metals, most chemicals and solvents. $\,$

Easy to use, Just apply and air dry.

Curing may be accelerated with mild heat.

Users Report:

- Bonds Silicon Carbide nozzles into alumina sleeving in a high temperature instrument chamber.
- Bonds Nickel pins, measuring 0.03" dia. into 0.04" holes in an aluminum nitride ceramic. These parts were quenched (from 900°C) in liquid Nitrogen without failure.
- Bonds Kanthal to Mullite tubes, forming inexpensive custom sized and durable high temp. Heating elements.

Applications Include: bonding alumina, metals, ceramics, graphite, electrical components, adhering thermocouples, heat sensors, and critical electronic components, in appliances, instruments, etc.

3000°F - RESBOND 989FS

Fast Set Alumina Adhesive

New, 989 Fast Set is specially formulated for applications requiring a fast setting, single component, alumina adhesive.

Now, a free flowing formulation that is ideal for use in automatic dispensing equipment. It is precisely dispensed through fine needles with out clogging or mess.

Resbond 989FS cures at room temp. or in 5 minutes at 200° F. It is the ideal choice for high speed production applications where automation is required.

3000°F - RESBOND 989F

Pre-Nano Adhesive

The Alumina used to formulate Resbond 989F particle size has been reduced to $600~\mathrm{nms}$.

Resbond 989F combines this ultra-fine Alumina with special high temperature colloidal ceramic binders to create an adhesive ideal for a new generation of applications.

Resbond 989F can be used in the finest dispensers. No clogs. No mess. It is an ideal choice for high temp. production applications.

Now, there are no limits to applications requiring a high temperature alumina adhesive and the ability to bond super fine electric components, bundles of fiber optics filaments,





	Resbond Continuous Use Temp. °F	989 3000	989FS 3000	989F 3000
	Base	Al ₂ O ₃	Al ₂ O ₃	Al ₂ O ₃
	Feature	General Purpose	Fast Set	0.6 Micron Ultra Fine
	Compressive Strength (psi)	3000	3500	2800
	Flexural Strength (psi)	1100	1250	950
	Thermal Expansion (x 10 ⁻⁶ /°F)	4.5	4.5	4.5
	Thermal Cond. (BTU in/hr. in ft ²)	15	15	12
	Dielectric Strength (volts/mil)	200	200	200
	Volume Resistivity (ohm - cm)	10 ⁸	10 ⁸	10 ⁸
	Components	1	1	1
	Color	White	White	White
	Consistency	Paint	Paint	Cream
	Cure R.T. (Hours)	2 - 4	½ - 2	2 - 4
	Cure 200°F (Hours)	½ - 1	5 mins.	1 - 2

Availability

NEW 989 FAST SET

Resbond 989FS-1 Pint Resbond 989FS-2 Quart

NEW 989 ULTRA FINE

Resbond 989F-1......... Pint Resbond 989F-2...... Quart

Production Pricing is Available upon Request

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